

## Features

- Excellent Package for Heat Dissipation
- Halogen Free. "Green" Device (Note 1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)
- Moisture Sensitivity Level 3

## Maximum Ratings

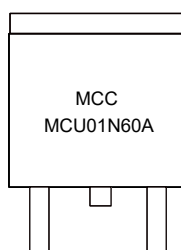
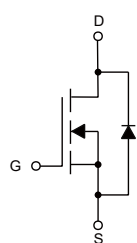
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 50°C/W Junction to Ambient<sup>(Note2)</sup>
- Thermal Resistance: 3.3°C/W Junction to Case

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	600	V
Gate-Source Voltage	$V_{GS}$	±30	V
Continuous Drain Current	$I_D$	$T_C=25^\circ\text{C}$	1.3
		$T_C=100^\circ\text{C}$	0.82
Pulsed Drain Current <sup>(Note3)</sup>	$I_{DM}$	5.2	A
Total Power Dissipation <sup>(Note4)</sup>	$P_D$	37.8	W
Single Pulsed Avalanche Energy <sup>(Note5)</sup>	$E_{AS}$	7.2	mJ

Note:

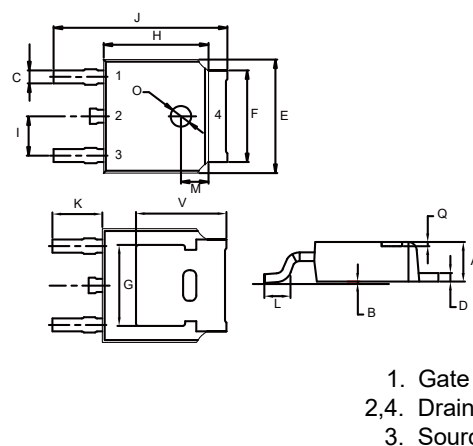
1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ .
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4.  $P_D$  is based on max. junction temperature, using junction-case thermal resistance.
5.  $V_{DD}=50\text{V}$ ,  $R_G=25\Omega$ ,  $L=10\text{mH}$ .

## Internal Structure and Marking Code



# N-CHANNEL MOSFET

## DPAK(TO-252)



DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.087	0.094	2.20	2.40	
B	0.000	0.005	0.00	0.13	
C	0.026	0.034	0.66	0.86	
D	0.018	0.023	0.46	0.58	
E	0.256	0.264	6.50	6.70	
F	0.201	0.215	5.10	5.46	
G	0.190		4.83		TYP.
H	0.236	0.244	6.00	6.20	
I	0.086	0.094	2.18	2.39	
J	0.386	0.409	9.80	10.40	
K	0.114		2.90		TYP.
L	0.055	0.067	1.40	1.70	
M	0.063		1.60		TYP.
O	0.043	0.051	1.10	1.30	
Q	0.000	0.012	0.00	0.30	
V	0.211		5.35		TYP.

**Electrical Characteristics @ 25°C (Unless Otherwise Specified)**

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	600			V
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 30V$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=600V, V_{GS}=0V$			1	$\mu A$
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	3.0	3.4	4.2	V
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=0.5A$		7.0	9.0	$\Omega$
Gate Resistance	$R_g$	F=1 MHz, Open drain		3.2		$\Omega$
<b>Diode Characteristics</b>						
Continuous Body Diode Current	$I_S$				1.3	A
Diode Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_S=0.5A$			1.4	V
Reverse Recovery Time	$t_{rr}$	$V_{DD}=300V, I_S=0.5A, di/dt=10A/\mu s$		490		ns
Reverse Recovery Charge	$Q_{rr}$			290		nC
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=20V, V_{GS}=0V, f=1MHz$		125		pF
Output Capacitance	$C_{oss}$			21.3		
Reverse Transfer Capacitance	$C_{rss}$			4.1		
Total Gate Charge	$Q_g$	$V_{DD}=300V, V_{GS}=10V, I_D=0.5A$		6.0		nC
Gate-Source Charge	$Q_{gs}$			0.9		
Gate-Drain Charge	$Q_{gd}$			3.1		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=300V, R_G=6\Omega, I_D=0.5A$		4.9		ns
Turn-On Rise Time	$t_r$			7.5		
Turn-Off Delay Time	$t_{d(off)}$			12.7		
Turn-Off Fall Time	$t_f$			63.9		

Fig. 1 - Typical Output Characteristics

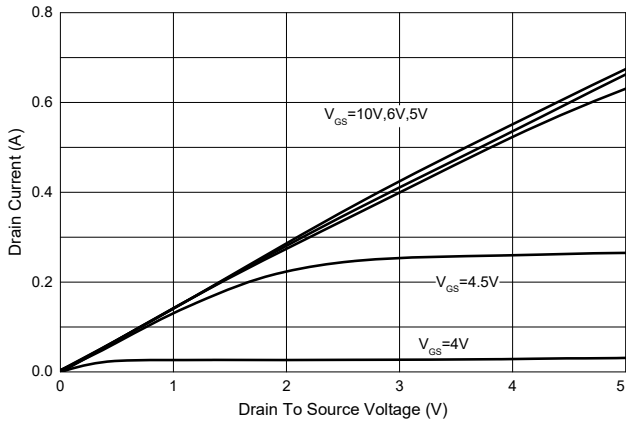


Fig. 2 - Transfer Characteristics

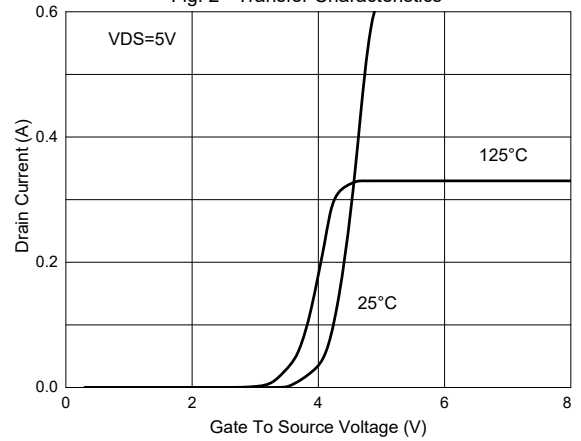


Fig. 3 -  $R_{DS(ON)} - I_D$

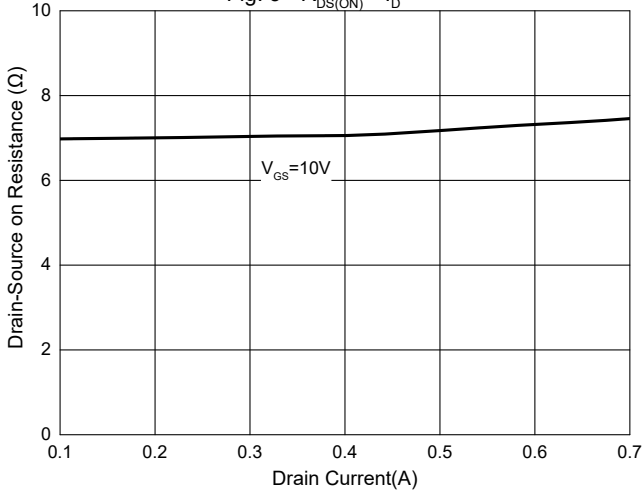


Fig. 4 -  $R_{DS(ON)} - V_{GS}$

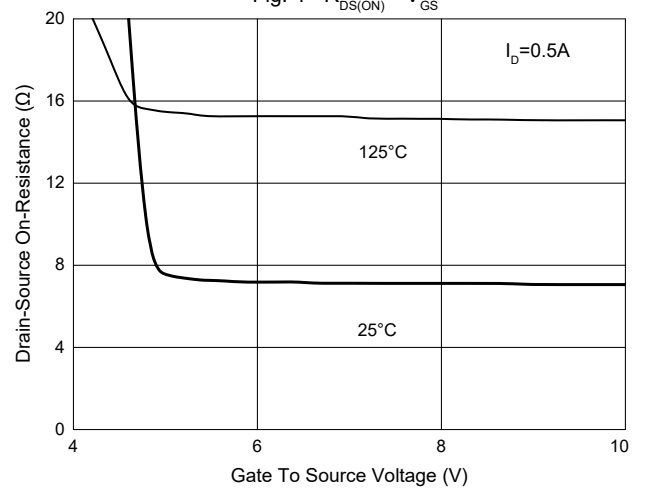


Fig. 5 - Normalized On Resistance Characteristics

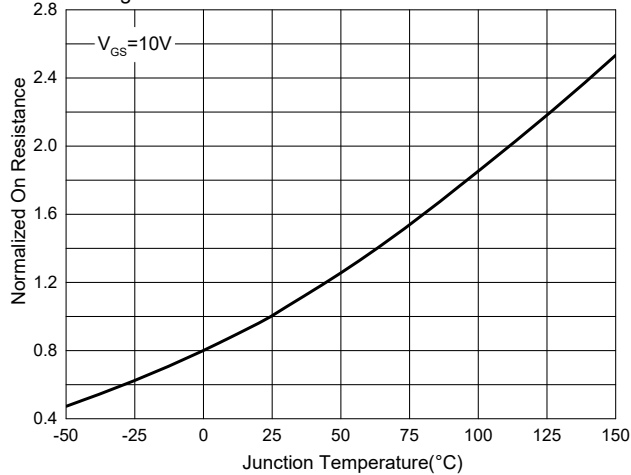
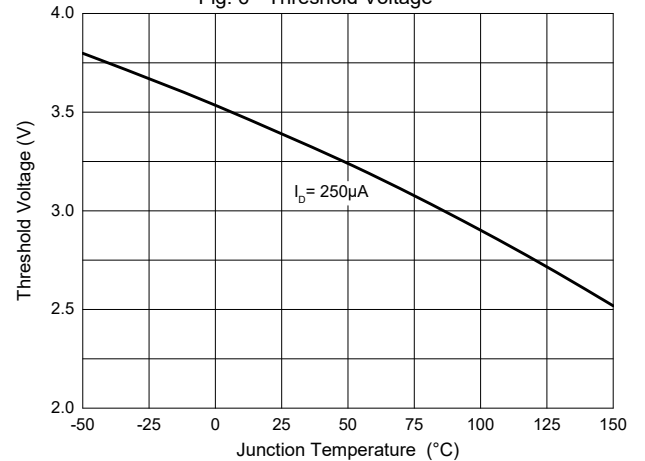


Fig. 6 - Threshold Voltage



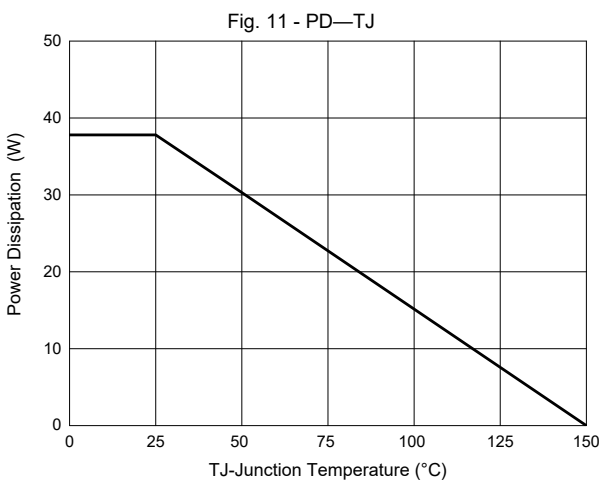
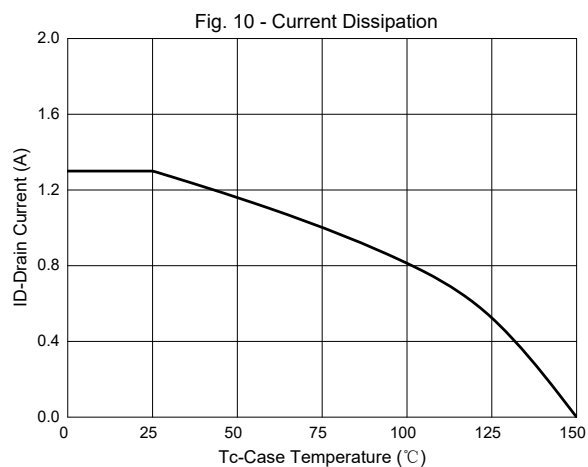
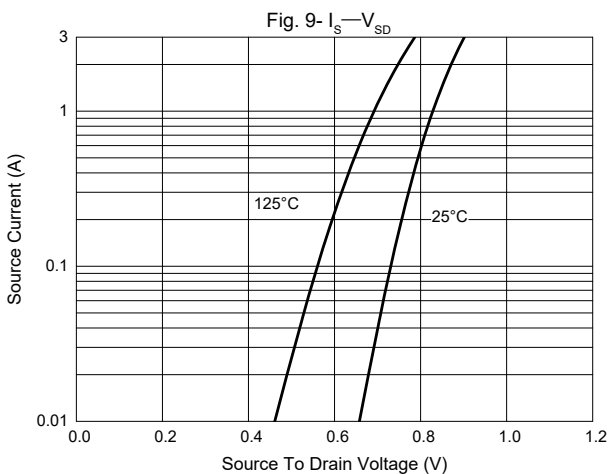
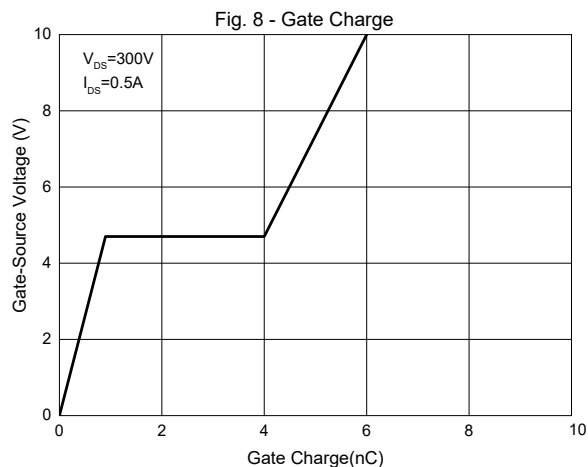
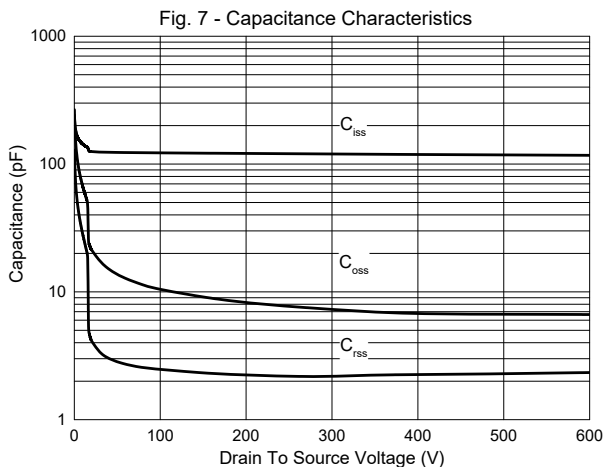


Fig. 12 - Safe Operation Area

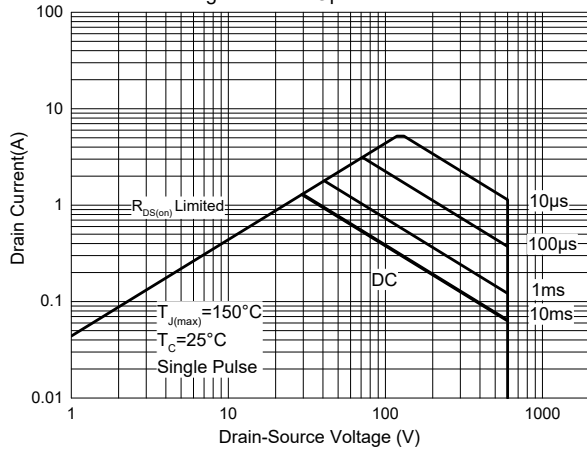
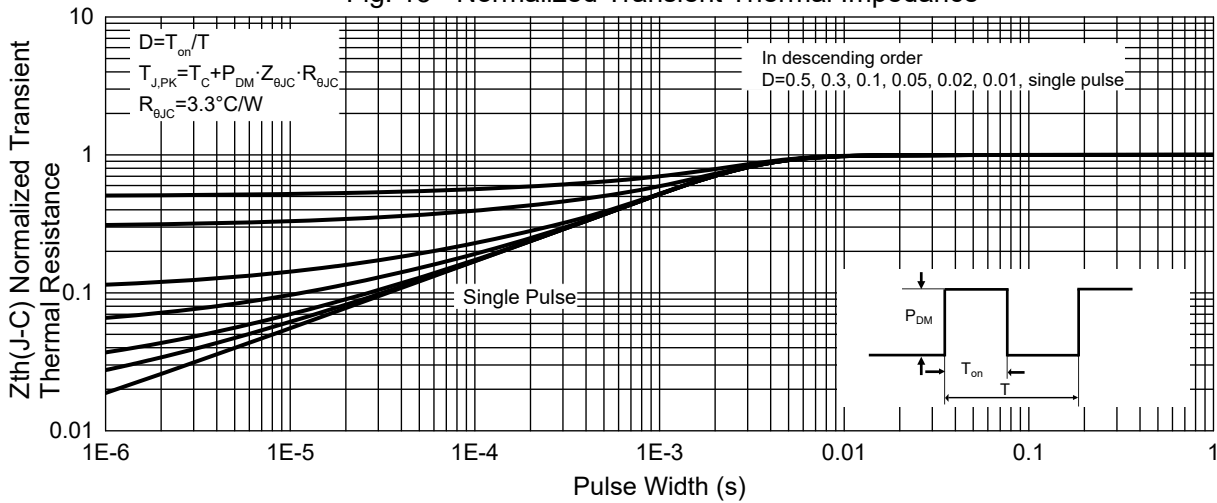


Fig. 13 - Normalized Transient Thermal Impedance



## Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 2.5Kpcs/Reel

## Revision History

Datasheet status	Version No	Release date	Update content
New product datasheet	Rev4-1	20230118	

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